

Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power-Loss, High Efficiency
- Surge Overload Rating to 50A Peak
- For Use in Low-Voltage, High-Frequency Inverters, Free-Wheeling, and Polarity Protection Application
- High-Temperature Soldering: +260°C/10 Second at Terminal
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Polarity: Cathode Band or Cathode Notch
- Weight: SMA 0.064 grams (Approximate) SMB 0.093 grams (Approximate)

SMA/SMB



Bottom View

Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
B2xxA-13-F	Standard	SMA	5,000/Tape & Reel
B2xx-13-F	Standard	SMB	3,000/Tape & Reel
B250Q-13	Automotive	SMB	3,000/Tape & Reel
B240AQ-13-F	Automotive	SMA	5,000/Tape & Reel
B240Q-13-F	Automotive	SMB	3,000/Tape & Reel

* x = Device type, e.g. B260A-13-F (SMA package); B240-13-F (SMB package).

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

5. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.

Marking Information

Notes:



B2X0A = Product type marking code, ex: B220A (SMA package) B2X0 = Product type marking code, ex: B230 (SMB package))'|' = Manufacturers' code marking YWW = Date code marking Y = Last digit of year (ex: 5 for 2015) WW = Week code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For cap Characteristic		B220/A	rent by 20% B230/A	B240/A	B250/A	B260/A	Unit
Characteristic	Symbol	BZZU/A	BZ30/A	D240/A	BZ30/A	6200/A	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	20	30	40	50	60	V
RMS Reverse Voltage	V _{R(RMS)}	14	21	28	35	42	V
Average Rectified Output Current	lo			2.0			А
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load			А				

Thermal Characteristics

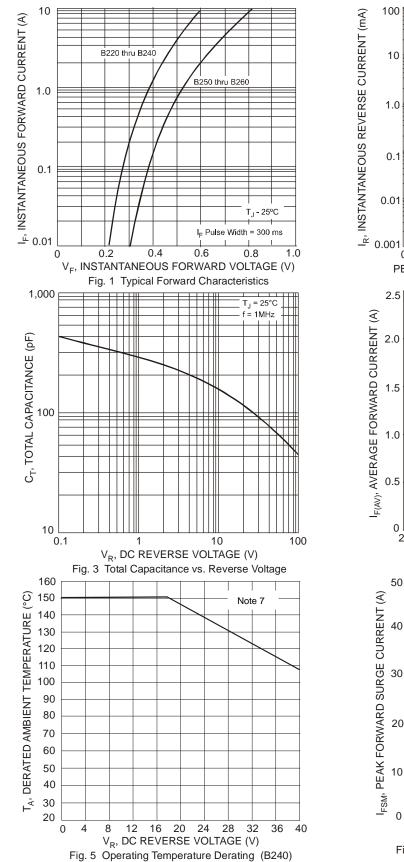
Characteristic	Symbol	Value	Unit	
Typical Thermal Resistance, Junction to Lead	SMA SMB	R _{eJL}	25 20	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-65 to +150	°C

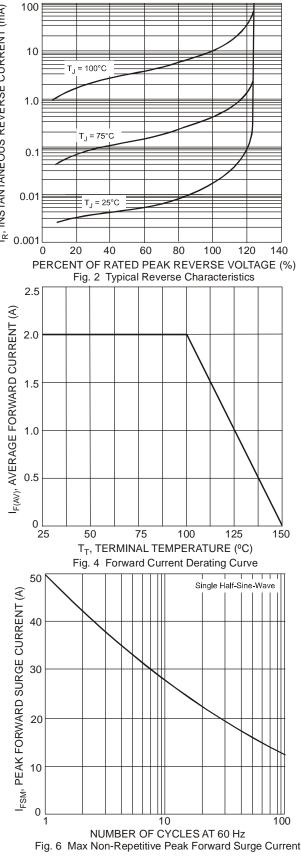
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop B220/A, B230/A, B240/A B250/A, B260/A		V-	-		0.50 0.70	V	I _F = 2.0A, T _A = +25°C
Leakage Current (Note 6)		I _R			0.5 20	mA	@ Rated V _R , T _A = +25°C @ Rated V _R , T _A = +100°C
Total Capacitance		CT			200	pF	$V_R = 40V$, f = 1MHz

Note: 6. Short duration pulse test used to minimize self-heating effect.







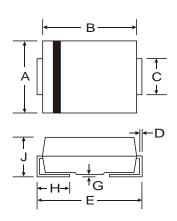
Note: 7. Device mounted on FR-4 PC board with minimum recommended pad layout pattern as per http://www.diodes.com.



Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

SMA/SMB

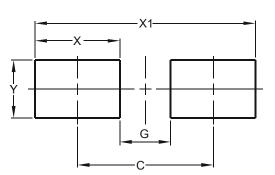


			-			
	SMA				SMB	
Dim	Min	Max		Dim	Min	
Α	2.29	2.92		Α	3.30	
В	4.00	4.60		В	4.06	
С	1.27	1.63		С	1.96	
D	0.15	0.31		D	0.15	
Е	4.80	5.59		E	5.00	
G	0.05	0.20		G	0.05	
Н	0.76	1.52		Н	0.76	
J	2.01	2.30		J	2.00	
All Dim	ensions	in mm		All Dim	ensions	•

Max 3.94 4.57 2.21 0.31 5.59 0.20 1.52 2.50 in mm

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



SMA/SMB E

SMA			
Dimensions Value (in mm)			
С	4.00		
G	1.50		
Х	2.50		
X1	6.50		
Y	1.70		

SMB			
Dimensions	Value (in mm)		
С	4.30		
G	1.80		
Х	2.50		
X1	6.80		
Y	2.30		



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